

Cree® XLamp® MX-3S LEDs



PRODUCT DESCRIPTION

The Cree XLamp MX-3S LED provides the proven lighting-class performance and reliability of Cree XLamp LEDs in a high-voltage, PLCC configuration. All members of the MX-family of LEDs have a wide viewing angle, uniform light output without secondary optics, unlimited floor life and electrically neutral thermal path.

The XLamp MX-3S LED brings high performance and quality of light to a range of lighting applications that require near-line-voltage configuration, including LED light bulbs, fluorescent retrofits and retail-display lighting.

FEATURES

- Available in white (2600 K to 8300 K CCT)
- Wide viewing angle: 120°
- 10.7 VDC nominal with voltage binning available
- Electrically neutral thermal path
- Qualification at maximum drive current
- Unlimited floor life at $\leq 30\text{ }^{\circ}\text{C}/85\%\text{ RH}$
- RoHS- and REACH-compliant
- UL-recognized component (E326295)



Flux Characteristics.....	2
Characteristics	2
Relative Spectral Power Distribution.....	3
Relative Flux vs. Junction Temperature	3
Electrical Characteristics.....	4
Relative Flux vs. Current	4
Thermal Design.....	5
Typical Spatial Distribution.....	5
Reflow Soldering Characteristics ..	6
Notes.....	7
Mechanical Dimensions.....	9
Tape and Reel	10
Packaging.....	11

FLUX CHARACTERISTICS ($T_j = 25\text{ }^{\circ}\text{C}$)

The following table provides several base order codes for XLamp MX-3S LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp MX Family LED Binning and Labeling document.

Color	CCT Range		Base Order Codes Min. Luminous Flux (lm) @ 115 mA		Order Code
	Min.	Max.	Group	Flux (lm)	
Cool White	5000 K	8300 K	Q5	107	MX3SWT-A1-0000-000D51
			R2	114	MX3SWT-A1-0000-000E51
Warm White	3700 K	4300 K	Q3	93.9	MX3SWT-A1-0000-000BE5
			Q4	100	MX3SWT-A1-0000-000CE5
	2600 K	3700 K	Q2	87.4	MX3SWT-A1-0000-000AE7
			Q3	93.9	MX3SWT-A1-0000-000BE7

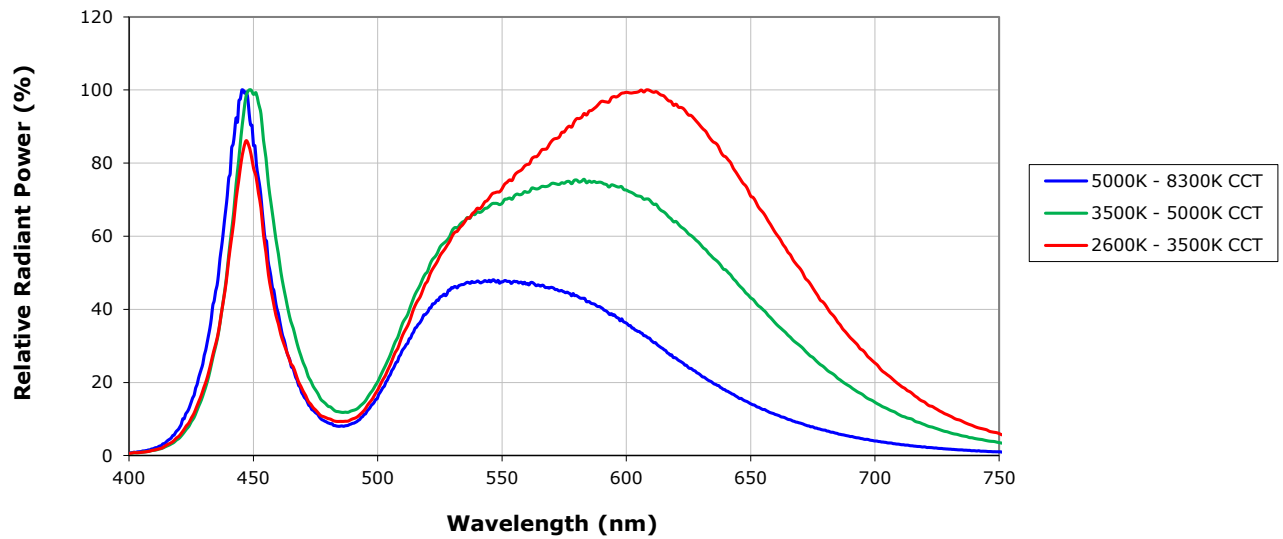
Notes:

- Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements, ± 0.005 on chromaticity (CCx, CCy) measurements and ± 2 on CRI measurements.
- Typical CRI for Cool White (4300 K – 8300 K CCT) is 75.
- Typical CRI for Warm White (2600 K – 4300 K CCT) is 80.

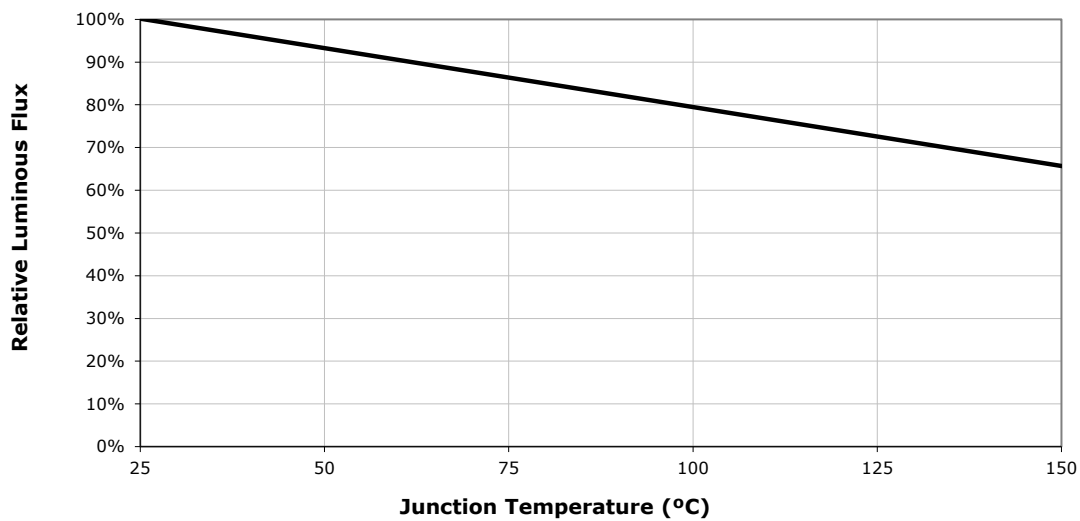
CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	$^{\circ}\text{C}/\text{W}$		11	
Viewing angle (FWHM)	degrees		120	
Temperature coefficient of voltage	$\text{mV}/^{\circ}\text{C}$		-13	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			175
Reverse voltage	V			-5
Reverse current	mA			-0.1
Forward voltage (@ 115 mA)	V		10.7	12.0
LED junction temperature	$^{\circ}\text{C}$			150

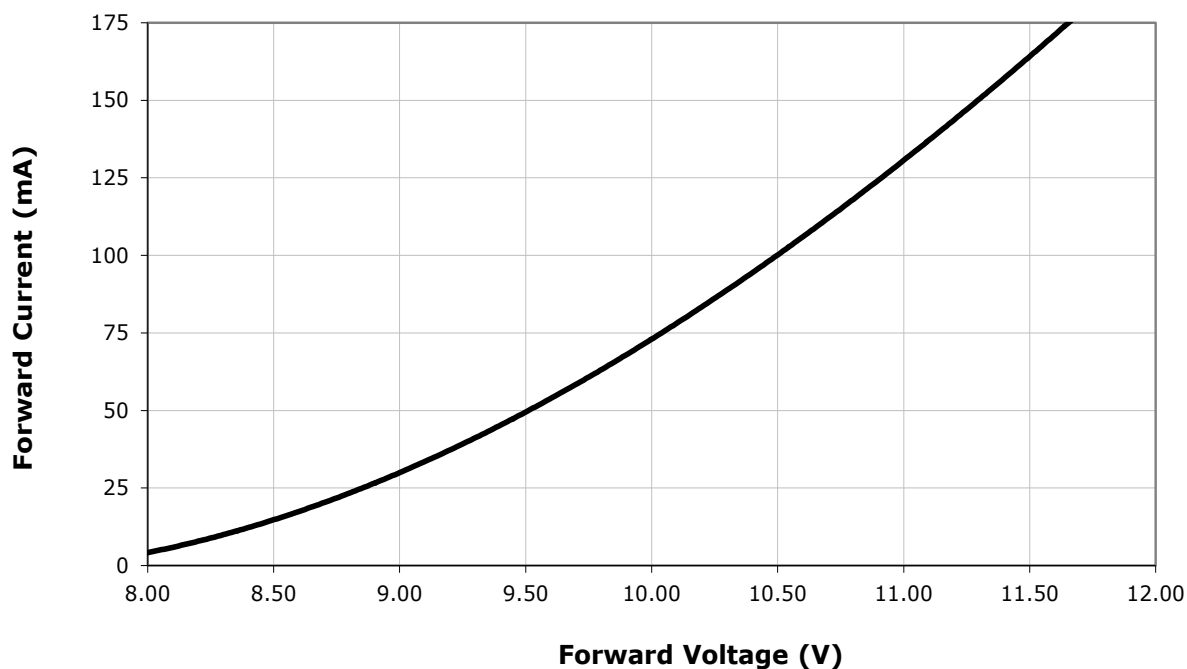
RELATIVE SPECTRAL POWER DISTRIBUTION



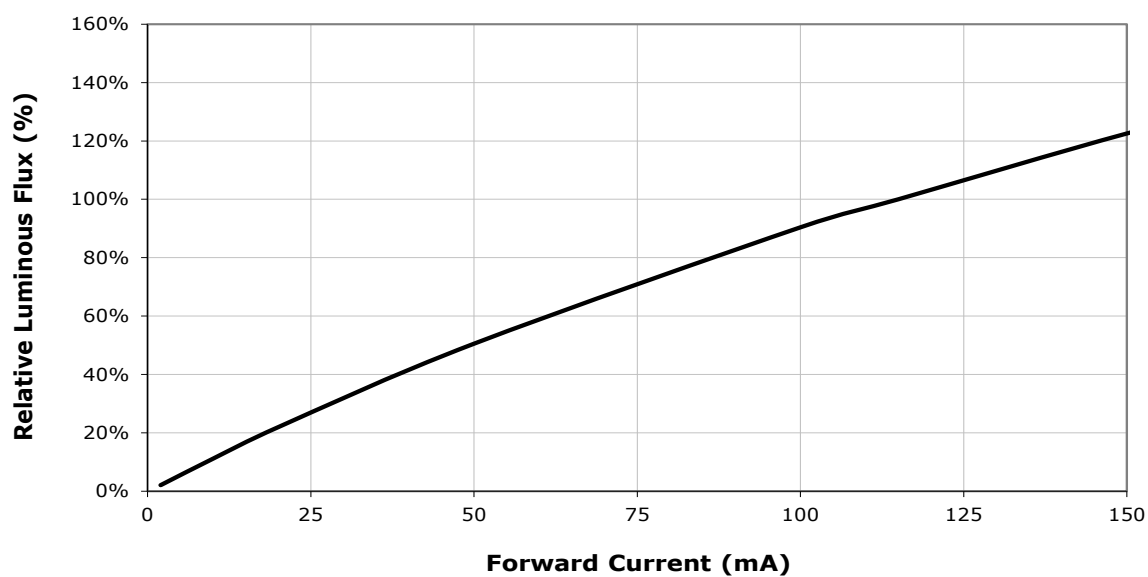
RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 115$ mA)



ELECTRICAL CHARACTERISTICS ($T_j = 25\text{ }^{\circ}\text{C}$)

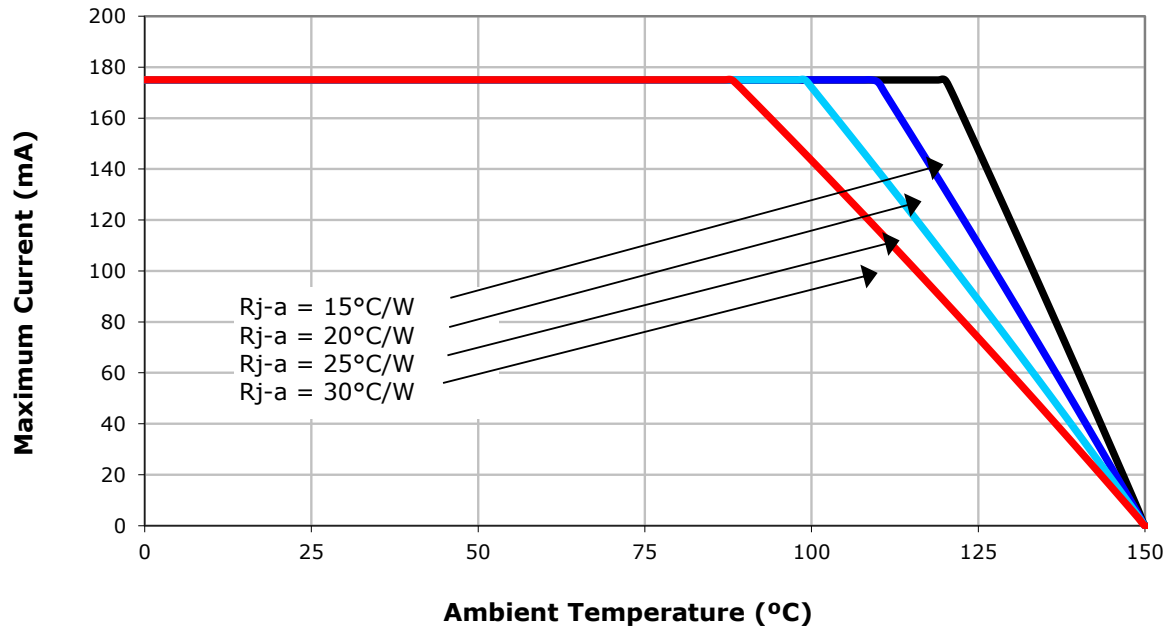


RELATIVE FLUX VS. CURRENT ($T_j = 25\text{ }^{\circ}\text{C}$)

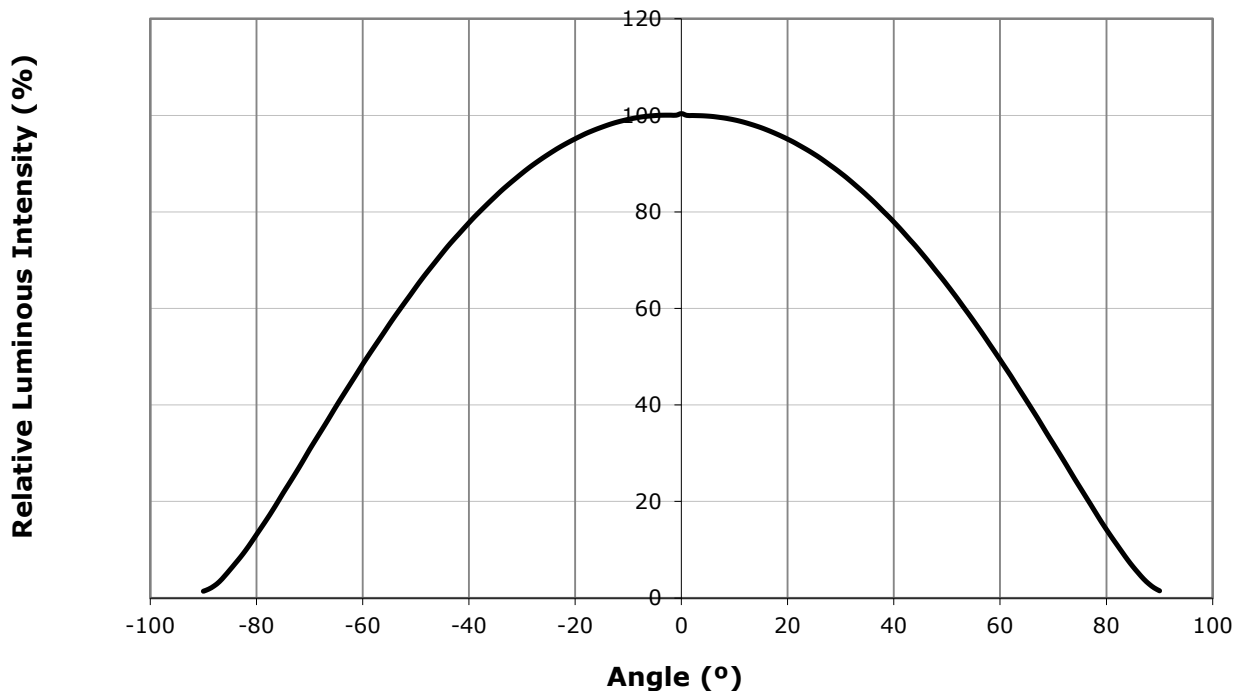


THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.



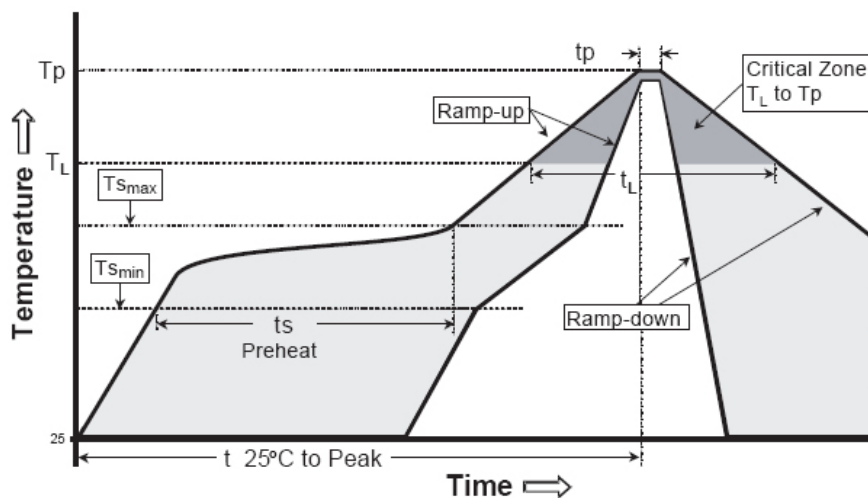
TYPICAL SPATIAL DISTRIBUTION



REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XM-L LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate ($T_{s_{max}}$ to T_p)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min ($T_{s_{min}}$)	100 °C	150 °C
Preheat: Temperature Max ($T_{s_{max}}$)	150 °C	200 °C
Preheat: Time ($t_{s_{min}}$ to $t_{s_{max}}$)	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T_L)	183 °C	217 °C
Time Maintained Above: Time (t_L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (T_p)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (t_p)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Notes:

- All temperatures refer to topside of the package, measured on the package body surface.
- While the high reflow temperatures (above) have been approved, Cree's best practice guideline for reflow is to use as low a temperature as possible during the reflow soldering process for these LEDs.

NOTES

Lumen Maintenance Projections

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document at www.cree.com/xlamp_app_notes/LM80_results.

For XLamp MX-3S Cree currently recommends a maximum drive current of 133 mA in designs seeking the ENERGY STAR* 35,000-hour lifetime rating ($\geq 94.1\%$ luminous flux @ 6000 hours) or 25,000-hour lifetime rating ($\geq 91.8\%$ luminous flux @ 6000 hours).

Please consult the XLamp Long-Term Lumen Maintenance application note at www.cree.com/xlamp_app_notes/lumen_maintenance for more details on Cree's lumen maintenance testing and forecasting. Please read the XLamp Thermal Management application note at www.cree.com/xlamp_app_notes/thermal_management for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

* These lifetime ratings are based on the current ENERGY STAR Product Specification for Luminaires (Light Fixtures) V1.0 (February 16, 2011) and ENERGY STAR Program Requirements for Integral LED Lamps V1.4 (May 13, 2011) lumen maintenance criteria.

Moisture Sensitivity

In testing, Cree has found XLamp MX-3S LEDs to have unlimited floor life in conditions $\leq 30\text{ }^{\circ}\text{C}/85\%$ relative humidity (RH). Moisture testing included a 168-hour soak at $85\text{ }^{\circ}\text{C}/85\%$ RH followed by 3 reflow cycles, with visual and electrical inspections at each stage.

Cree recommends keeping XLamp LEDs in their sealed moisture-barrier packaging until immediately prior to use. Cree also recommends returning any unused LEDs to the resealable moisture-barrier bag and closing the bag immediately after use.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as amended through June 8, 2011. RoHS Declarations for this product can be obtained from your Cree representative or obtained from the Product Ecology section of www.cree.com.

REACH Compliance

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notices of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACH Declaration. Historical REACH banned substance information (substances restricted or banned in the EU prior to 2010) is also available upon request.

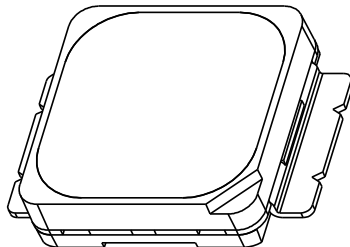
Vision Advisory Claim

WARNING: Do not look at exposed lamp in operation. Eye injury can result. See LED Eye Safety at www.cree.com/xlamp_app_notes/led_eye_safety.

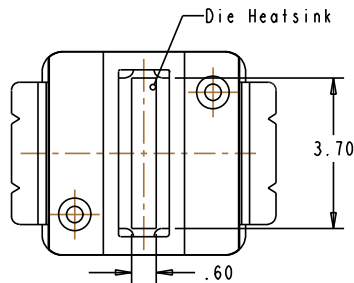
MECHANICAL DIMENSIONS

All measurements are ± 0.13 mm unless otherwise indicated.

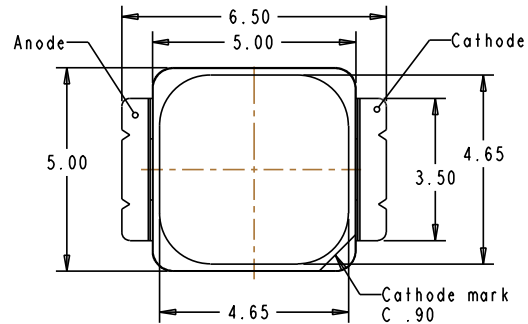
Top View



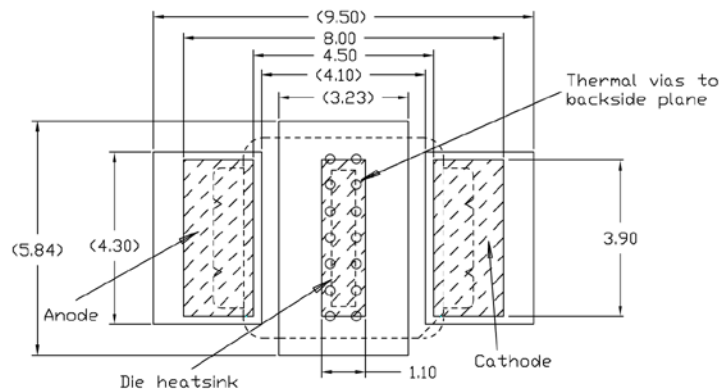
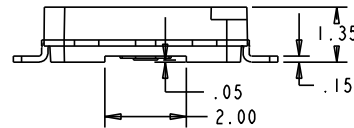
Bottom View



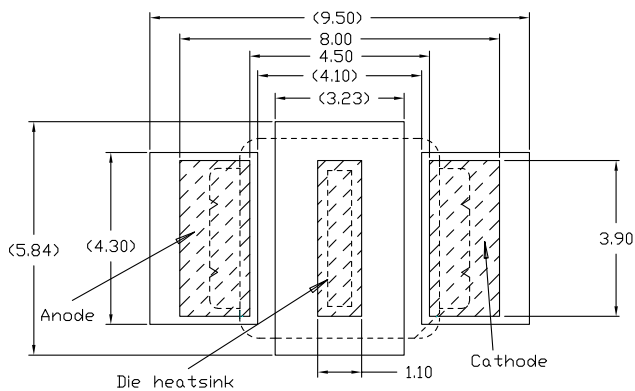
Top View



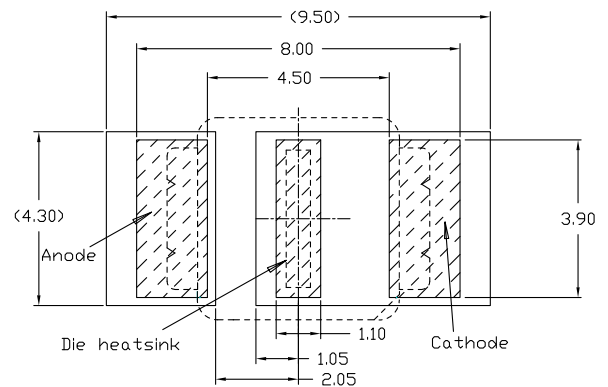
Side View



Recommended FR4 Solder Pad



Recommended MCPCB Solder Pad

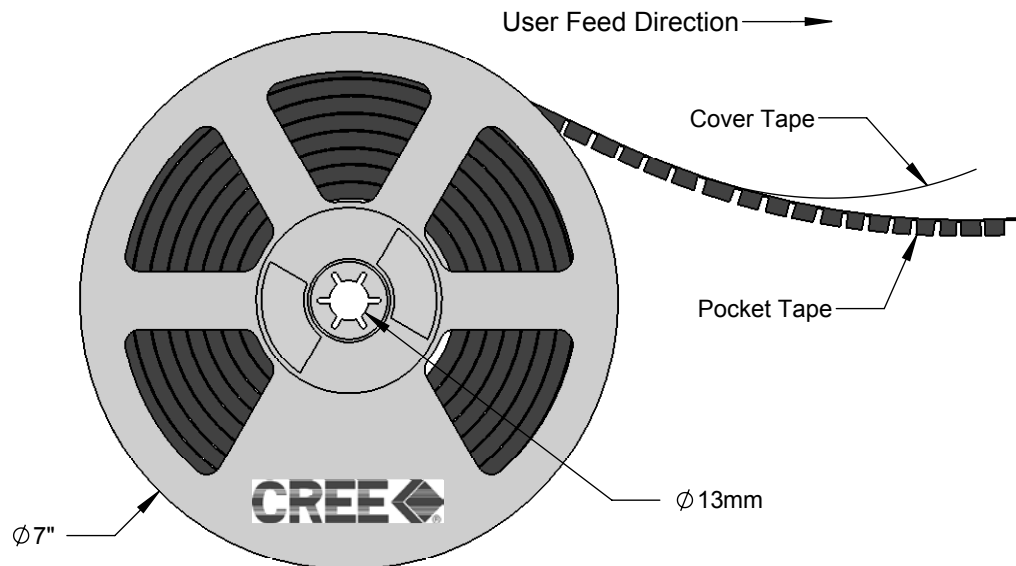
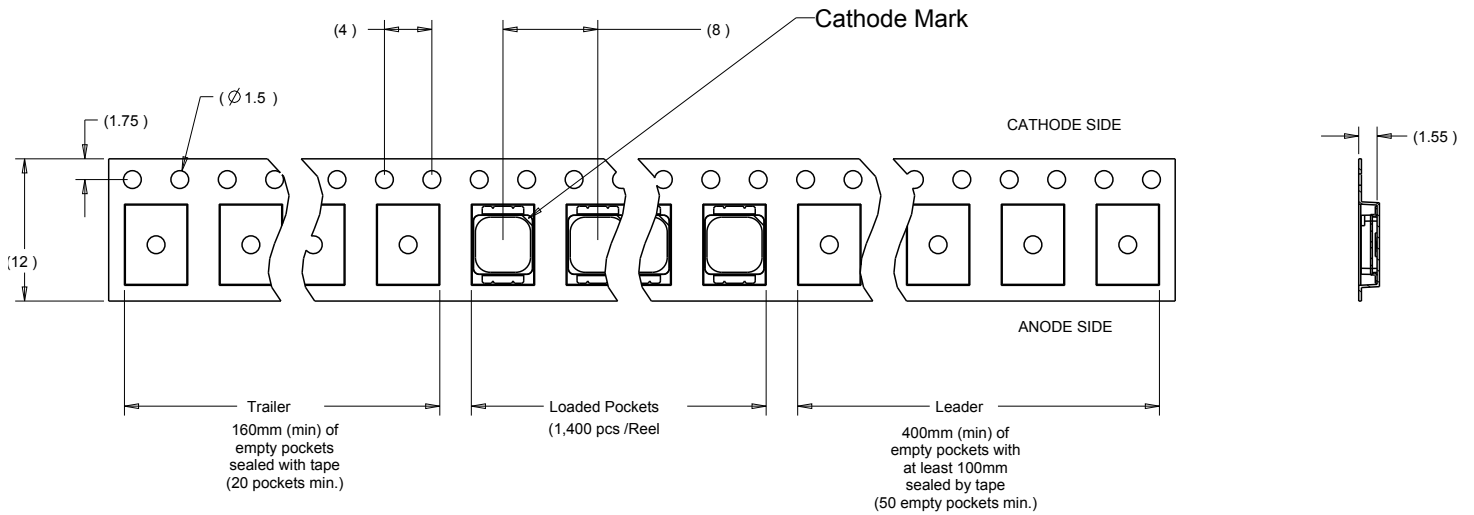


Alternative Solder Pad

TAPE AND REEL

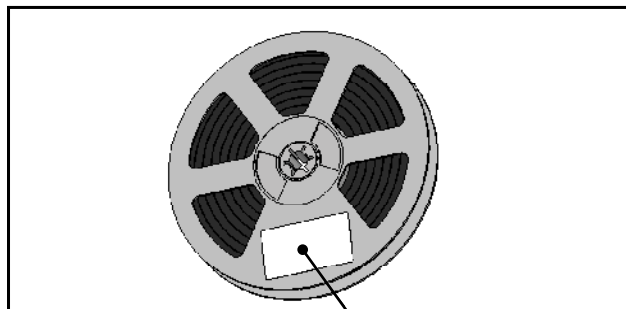
All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

All dimensions in mm.



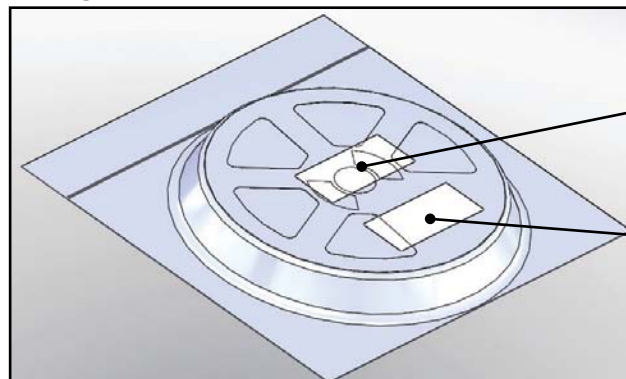
PACKAGING

Unpackaged Reel



Label with Cree Bin Code, Qty, Reel ID

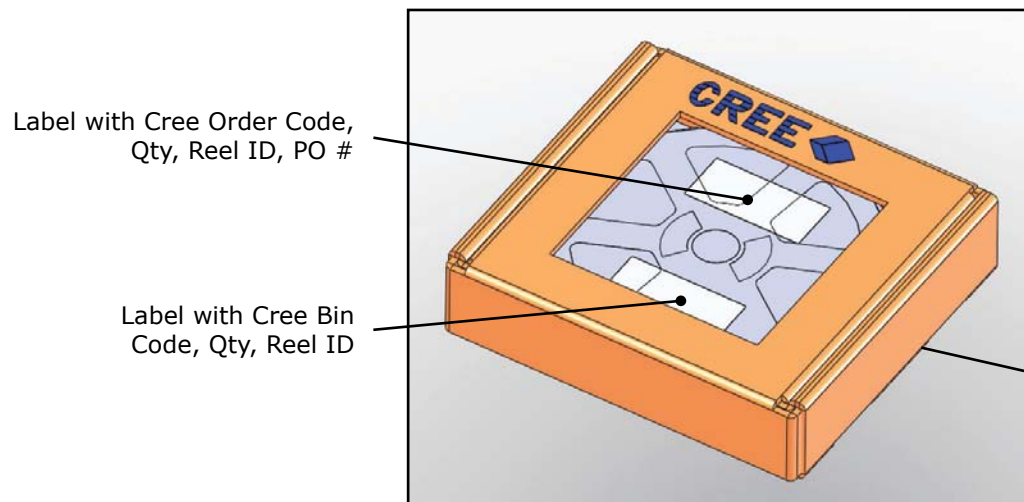
Packaged Reel



Label with Cree Order Code, Qty, Reel ID, PO #

Label with Cree Bin Code, Qty, Reel ID

Boxed Reel



Label with Cree Order Code, Qty, Reel ID, PO #

Label with Cree Bin Code, Qty, Reel ID

Patent Label (on bottom of box)